

| Company                   | WAVICE   | Company Logo |
|---------------------------|--|--------------|
| Name                      |  | 1 7 3        |
|                           | 46, Samsung 1-ro 5-gil,  |              |
| Address                   | Hwaseong-si, Gyeonggi-do,  |              |
|                           | Republic of Korea  |              |
| President                 | Min Seog Han   |              |
| Website                   | www.wavice.com   | WAY WAVICE   |
| E-mail                    | kate@wavice.com  |              |
| Telephone                 | +82-10-9132-8716   |              |
| Fax                       | +82-31-260-8699  |              |
| Exhibitor<br>Introduction | Wavice Inc. is a leading GaN RF power semiconductor company specializing in the design and manufacturing of high-power amplifiers, MMICs, and SSPA modules for advanced defense, satellite, and communication systems.  With proprietary GaN device technology and in-house fabrication capabilities, Wavice provides high-efficiency and high-reliability RF solutions optimized for mission-critical applications such as radar, electronic warfare, and anti-drone systems.  Through continuous innovation across device, module, and system levels, Wavice is shaping the future of GaN RF technology and strengthening global   |              |
| Exhibit<br>Description    | defense capabilities.  Wavice Inc. demonstrates its leadership in GaN RF power technology through advanced high-power amplifier (HPA) modules, X-band and S-band GaN MMICs, and precision radar transceiver modules.  Wavice has successfully developed X-band GaN technology and directly produces domestic GaN wafers through its in-house GaN fabrication facility—the only one of its kind in Korea.  The company has also launched a 0.2-µm GaN foundry service, establishing a fully integrated GaN supply chain (Total GaN Solution) that covers device design, wafer fabrication, packaging, and mass production.  Currently, the X-band MMIC is available in QFN package samples, reflecting Wavice's ongoing expansion into standardized, production-ready packaging solutions.  Wavice's HPA products are already exported to defense and communication markets worldwide, delivering high power, high efficiency, and high |              |



|                 | <b>reliability</b> optimized for next-generation radar, electronic warfare, and satellite systems. |  |
|-----------------|--|--|
| Exhibit Product | GaN MMIC (QFN, FEM), GaN Wafer, GaN Transistor,<br>0.2μm Foundry Service, HPA, Module              |  |